

Cross point mixer for telephones

BU8241F / BU8241FS / BU8242F / BU8244F

The BU8241F, BU8241FS, BU8242F, and BU8244F are ICs developed for use with cordless telephones, and are equipped with switching and mixing functions. In addition, these ICs are provided with an internal power save function which enables the circuit to be run on line current if the power supply fails, by connecting a switch between the circuit and a new handset, reducing line current consumption. A series of these ICs is also under development, based on the number of circuits.

Product	No. of circuits
BU8241F / BU8241FS	8×8 matrix
BU8242F	6×6 matrix
BU8244F	4×4 matrix

●Applications

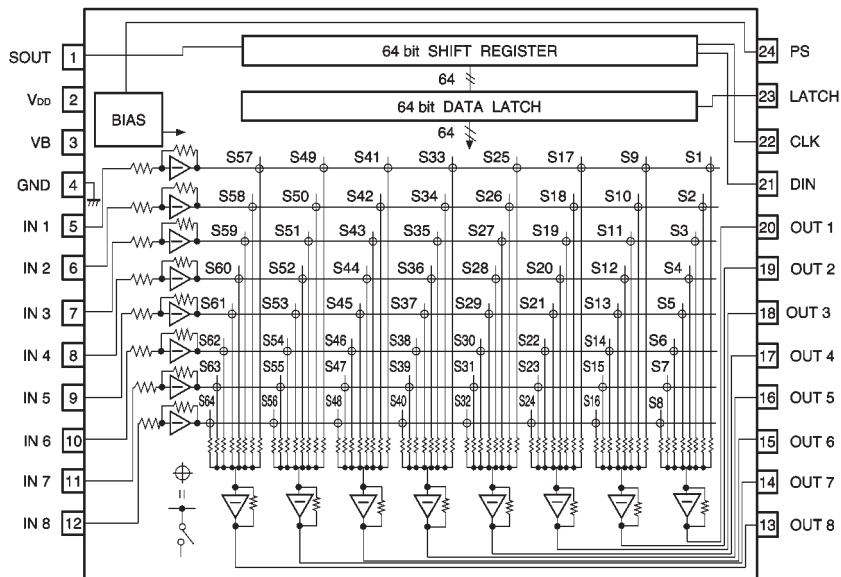
Telephones, telephone answering machines, cordless telephones

●Features

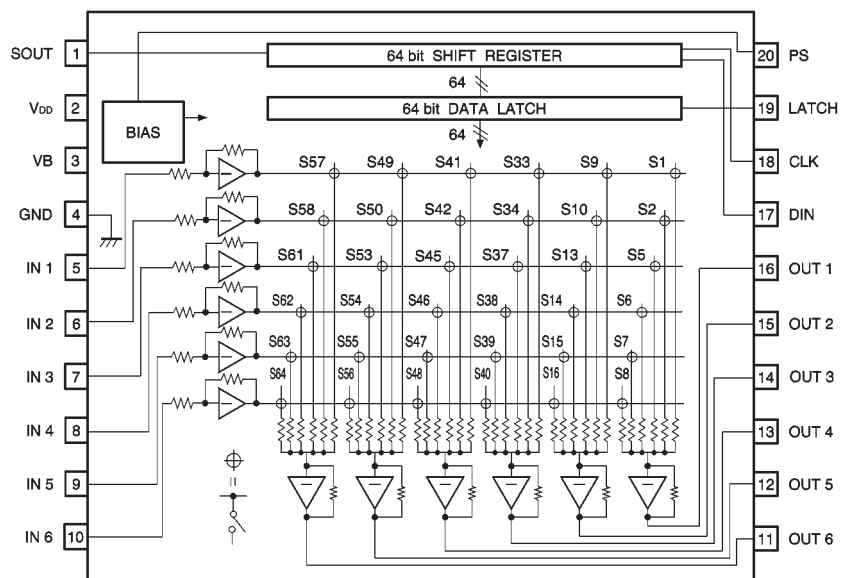
- 1) Eight input signals are selected and mixed by a cross-point, and output to eight pins (BU8241F/BU8241FS).
- 2) A power save mode enables the circuit to run on line current if the power supply fails.
 1. Line current consumption reduced
($I_{DD2} = 580\mu\text{A}$)
 2. $\text{IN1} \rightarrow \text{OUT1}$ and $\text{IN2} \rightarrow \text{OUT2}$ only are on
- 3) Serial binary data input.
- 4) Low voltage and current consumption.

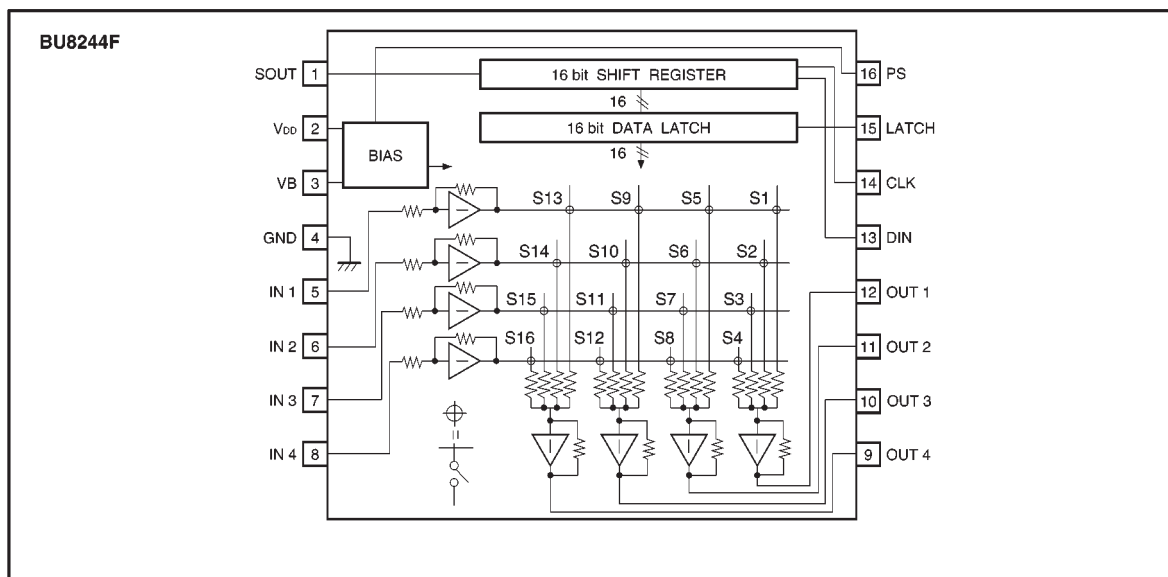
● Block diagram

BU8241F/BU8241FS



BU8242F





● Absolute maximum ratings (Ta = 25°C)

Parameter	Symbol	Limits	Unit
Power supply voltage	V _{DD}	7	V
Input voltage	V _{IN}	GND-0.3~V _{DD} +0.3	V
Output voltage	V _{OUT}	GND-0.3~V _{DD} +0.3	V
Power dissipation	Pd	550 (BU8241F / BU8242F) *1	mW
		800 (BU8241FS) *2	
		500 (BU8244F) *3	
Operating temperature	T _{opr}	-25~+75	°C
Storage temperature	T _{stg}	-55~+125	°C

*1 Reduced by 5.5mW for each increase in Ta of 1°C over 25°C.

*2 Reduced by 8mW for each increase in Ta of 1°C over 25°C.

*3 Reduced by 5mW for each increase in Ta of 1°C over 25°C.

● Recommended operating range (Ta = 25°C)

Parameter	Symbol	Range	Unit	Conditions
Power supply voltage	V _{DD}	2.7~5.5	V	
Input voltage	V _{in}	≤0	dBV	
Clock frequency	f _{CLK}	≤1	MHz	Duty 50%
Output load resistance	R _L	10≤	kΩ	Complete analog signal output terminal

●Electrical characteristics (unless otherwise noted, Ta = 25°C, V_{DD} = 5V)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Supply current 1	I _{DD1}	3.2	4.8	8.0	mA	Normal operation, with output pins open *1
		1.5	2.5	4.0	mA	Normal operation, with output pins open *2
Supply current 2	I _{DD2}	400	580	760	μA	In power save mode, with output pins open, at V _{DD} =3 V
Input high level voltage	V _{IH}	0.8V _{DD}	—	V _{DD}	V	DIN, CLK, LATCH, and PS pins
Input low level voltage	V _{IL}	GND	—	0.2V _{DD}	V	DIN, CLK, LATCH, and PS pins
Input high level current	I _{IH}	—	—	2	μA	DIN, CLK, LATCH, and PS pins
Input low level current	I _{IL}	—	—	2	μA	DIN, CLK, LATCH, and PS pins
Output saturation high level voltage	V _{OH}	0.9V _{DD}	—	—	V	I _{OH} =−100 μA, SOUT pin
Output saturation low level voltage	V _{OL}	—	—	0.1V _{DD}	V	I _{OL} =100 μA, SOUT pin
VB pin voltage	V _{VB}	2.13	2.50	2.88	V	No load
Input impedance	Z _{IN}	48	80	112	kΩ	f _{in} =1kHz, ν _{in} =0dBV, all analog input pins

〈Cross-point unit〉

Gain	GT	−1	0	1	dB	f _{in} =1kHz, ν _{in} =0dBV
Distortion	DT	—	0.1	0.5	%	f _{in} =1kHz, ν _{in} =−10dBV
Maximum output level	ν OM	0	3	—	dBV	f _{in} =1kHz, THD=5%
Noise level 1	NT1	—	−80	−70	dBV	BPF = 400 to 30 kHz, 4-channel mixing
Noise level 2	NT2	—	−90	—	dBV	BPF = 400 to 30 kHz, any one channel
Muting ratio	ν MR	—	−90	−80	dB	f _{in} = 1kHz, ν _{in} = 0dBV, BPF=1kHz*3
Crosstalk	ν CT	—	−80	−70	dB	f _{in} = 1kHz, ν _{in} = 0dBV, BPF=1kHz*4
Minimum operating power supply voltage	VMin.	—	—	2.4	V	Operation is guaranteed at these values, but the characteristics noted on this table are not guaranteed.

〈Shift register and data latch unit〉

Data setup time	t _{SU}	100	—	—	nsec	DIN→CLK
Data hold time	t _H	100	—	—	nsec	CLK→DIN
Clock latch time	t _{CL}	100	—	—	nsec	CLK→LATCH

*1 Applicable to the BU8241F, BU8241FS and BU8242F.

*2 Applicable to the BU8244F.

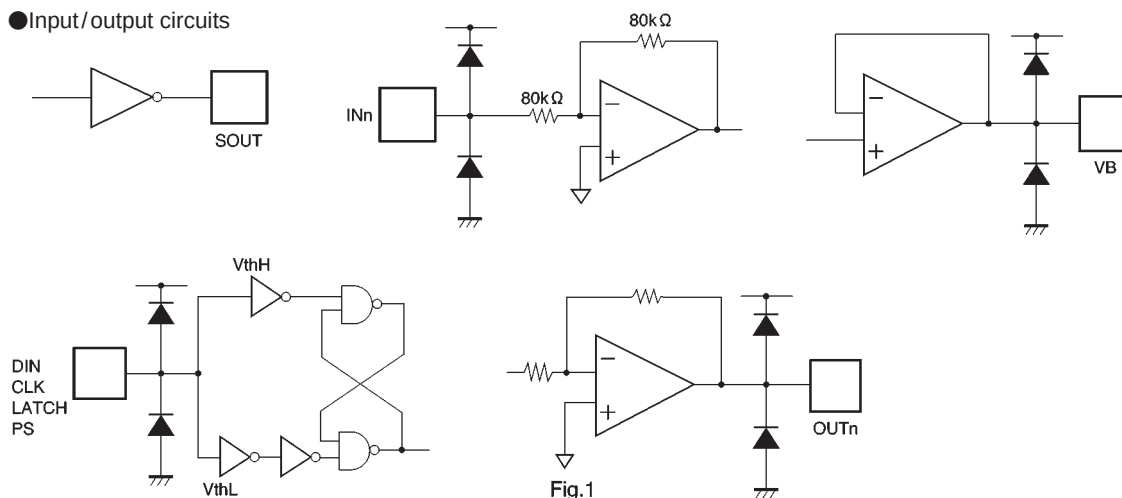
*3 On/Off ratio for the same channel.

*4 Signal leakage between different channels.

● Pin descriptions

BU8241F / BU8241FS Pin No.	BU8242F Pin No.	BU8244F Pin No.	Pin name	Function
1	1	1	SOUT	Serial output data pin for cascade connection
2	2	2	V _{DD}	Power supply pin
3	3	3	VB	Bias decoupling pin
4	4	4	GND	Ground pin
5	5	5	IN1	Signal input pin
6	6	6	IN2	Signal input pin
7	7	7	IN3	Signal input pin
8	8	8	IN4	Signal input pin
9	9	—	IN5	Signal input pin
10	10	—	IN6	Signal input pin
11	—	—	IN7	Signal input pin
12	—	—	IN8	Signal input pin
13	—	—	OUT8	Signal output pin
14	—	—	OUT7	Signal output pin
15	11	—	OUT6	Signal output pin
16	12	—	OUT5	Signal output pin
17	13	9	OUT4	Signal output pin
18	14	10	OUT3	Signal output pin
19	15	11	OUT2	Signal output pin
20	16	12	OUT1	Signal output pin
21	17	13	DIN	Serial input data pin
22	18	14	CLK	Shift clock input pin for shift register
23	19	15	LATCH	Latch input pin for data latch
24	20	16	PS	Power save setting input pin

● Input/output circuits



● Circuit operation

Sections (1) to (3) below describe operation using the BU8241F and BU8241FS as examples.

(1) Analog signals pass through an input amplifier and are supplied to eight switches.

The analog input signals are turned on and off by the switches and can thus be directed to any desired output amplifier. Using mixing resistors connected to the outputs of the switches, and feedback resistors, each output amplifier can output a signal that is a mix of up to eight input signals.

(2) The switch states are set using a 64-bit shift register and data latch.

The shift register reads the data at the rising edge of the shift clock, and stores it until the next data is read at the rising edge of the next shift clock.

After the 64 data bits have been read, supply of the rising edge of the clock is stopped, the LATCH pin is set to HIGH, and the switches are set. (See Figure 2 for the timing waveform.)

To change a switch setting, new setting data and shift clocks must be supplied for 64 bits of data, and the LATCH pin set to HIGH. If the LATCH pin is set to HIGH before 64 shift clocks have been supplied, or after more than 64 have been supplied, the switches cannot be set properly. (See Table 1 for the logic of switch settings.)

Table.1 Switch Sn stage (Note 6)

Data Dn (Note 6)	Switch Sn state (Note 6)
H	ON
L	OFF

(Note 11) Equivalent to $n = 1 \sim 64$

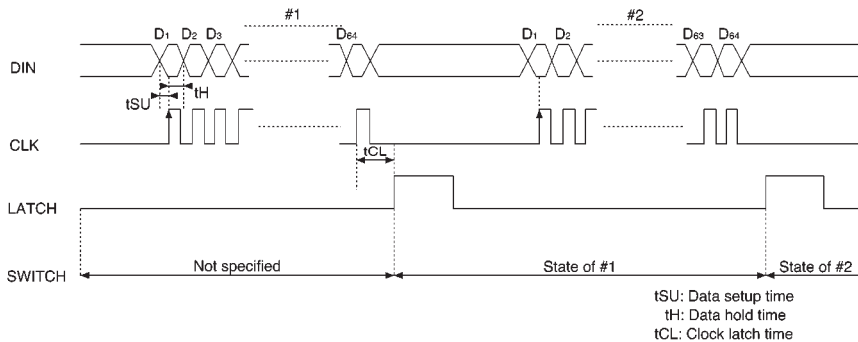


Fig. 2 Timing waveform

(3) The power save mode is set as long as the PS pin is kept HIGH. (See Table 2 for the power save setting logic.) In the power save mode, the following are fixed : IN1 → OUT1 (S1 = ON) and IN2 → OUT2 (S10 = ON). (The other 62 switches are off.) In addition, the line current is reduced. When the PS pin goes from HIGH to LOW, the IC state switches from the power save mode back to normal operation. At that point, the state of the switch remains in the power save mode (only S1 and S10 are on). (See Figure 3 for the timing waveform in the power save mode.)

(4) With the BU8242F, of the 64 data bits, the following should be input at LOW level : D₃, D₄, D₁₁, D₁₂, D₁₇ to D₃₂, D₃₅, D₃₆, D₄₃, D₄₄, D₅₁, D₅₂, D₅₉, and D₆₀.

(5) With the BU8244F, DIN is 16 bits.

The ON path in the power save mode is the same for the BU8241F and BU8241FS, but the pertinent switches are S1 and S6.

Table.2 Power save setting theory

PS pin	State
L	Normal operating mode
H	Power save mode

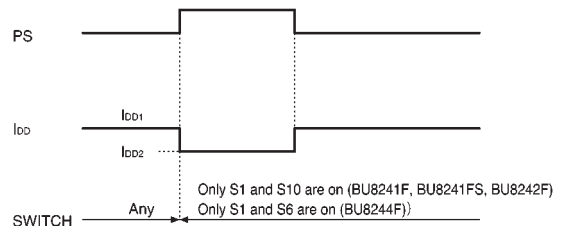


Fig. 3 Power save mode timing waveform

●Application example

The BU8241F and BU8241FS are shown in this example.

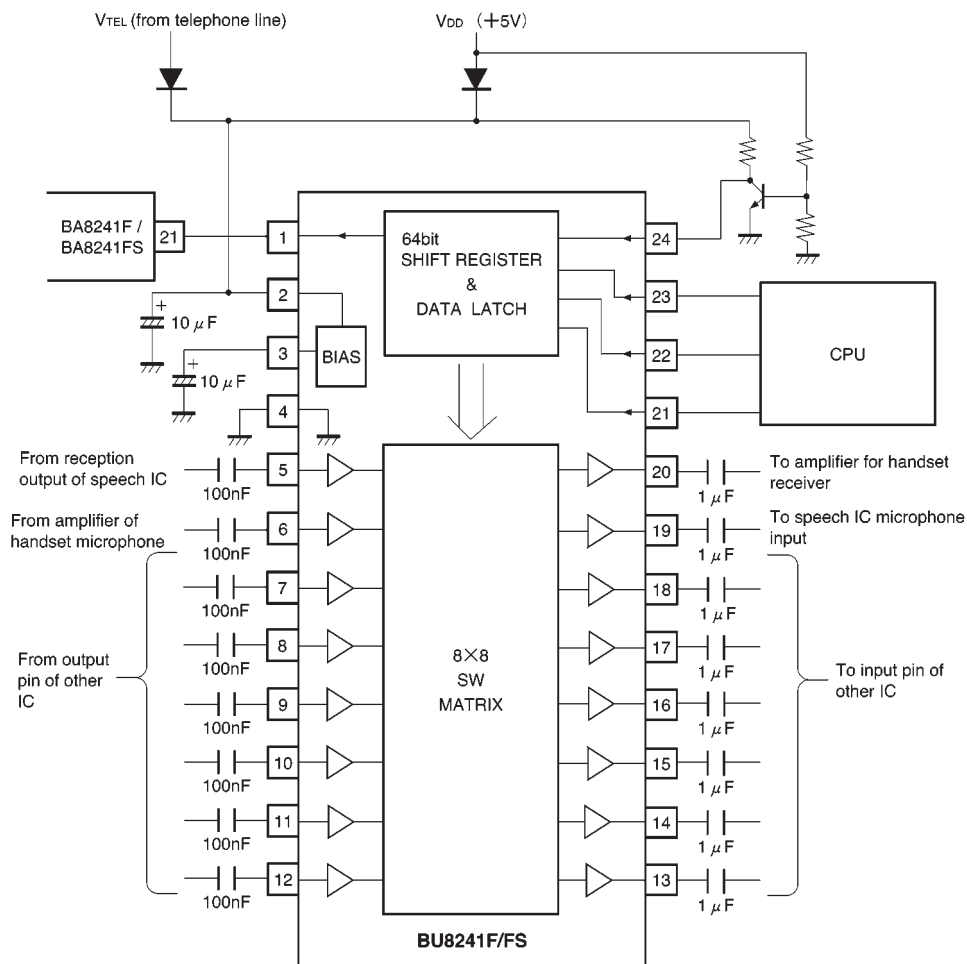


Fig.4

● Selecting attached components

1) Components related to power supply and bias

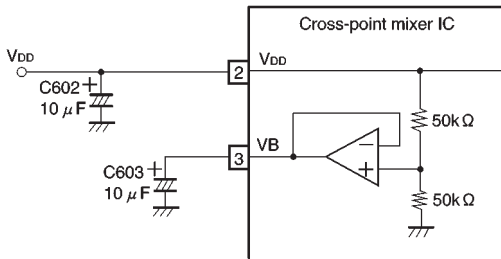


Fig. 5 Power supply and bias circuit

C602: V_{DD} bias capacitor; normally $10\mu\text{F}$

C603: VB decoupling capacitor; normally $10\mu\text{F}$

2) Components related to input pins

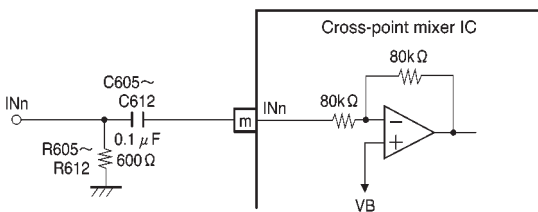


Fig. 6 Input circuit

C605 to C612: DC cutoff capacitor. A value should be selected which does not attenuate voice signals in the high band (300 Hz ~).

R605 to R612: Resistor which sets the input level. This should normally be left open.

The constants shown in Figure 8 are set to match the oscillator output impedance.

3) Components related to output pins

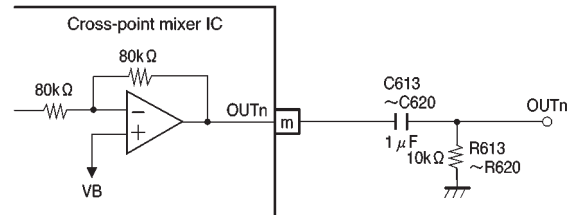


Fig. 7 Output circuit

C613 to C620: DC cutoff capacitor. A value should be selected which does not attenuate voice signals in the high band (300 Hz ~).

R613 to R620: Output load resistors. This should normally be left open.

If using R615 to R620, select values that result in a total input impedance of $10\text{k}\Omega$ or greater on the output side. If the total impedance is less than $10\text{k}\Omega$, the load on the output amplifier of the cross-point mixer will be excessive, and signals may be lost.

● Operation notes

(1) Turning on the power supply

When the power supply is turned on, the shift register is in an indeterminate state. After turning on the power supply, switch settings should be entered by supplying shift clock pulses to shift 64 bits of data into the shift register, and then setting the LATCH pin to HIGH. (For the BU8244, send 16 clock pulses.)

(2) Setting serial data

If the number of bits shifted or clock pulses applied is less than or more than the number stated above, the switches will not be set properly. Never apply shift clock pulses when the LATCH pin is HIGH. Doing so will change the data latch contents.

(3) Drive impedance

The input impedance Z_{in} is $80 \pm 32 \text{ k}\Omega$.

To suppress input gain and loss, we recommend using the drive impedance shown in the table below.

If the level is to be attenuated at the input pin, make sure the level is not affected by the internal resistance of the IC, as shown in Figure 10. This can cause gain and/or loss.

Gain/loss	Drive impedance
1 dB max.	4 k Ω max.
0.5 dB max.	2 k Ω max.

(4) Gain and noise when mixing signals

Increasing the number of signals mixed in a single output (increasing the number of switches connected to the same output amplifier that are on) causes a slight drop in gain. With the BU8241 and BU8241FS/BU8242F, increasing the number of signals mixed in a single output (increasing the number of switches connected to the same output amplifier that are on) causes a slight increase in the noise level in terms of logic. If noise is a problem, we recommend limiting the number of signals mixed in a single output.

(5) Output load capacitance

The capacitance connected to GND in relation to an output pin (the output load capacitance) should be kept to 50pF or lower. (BU8241F/BU8241FS/ BU8242F)

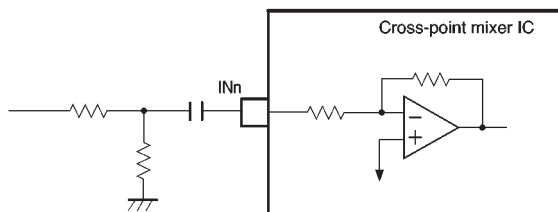


Fig. 8 Attenuation circuit with input

● Electrical characteristic curves

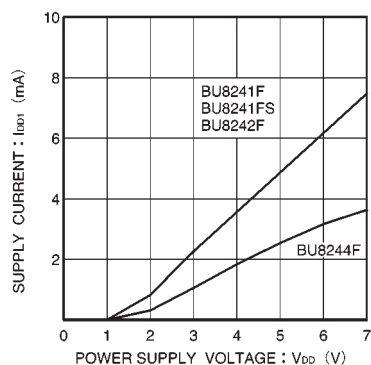


Fig. 9 Supply current vs. power supply voltage

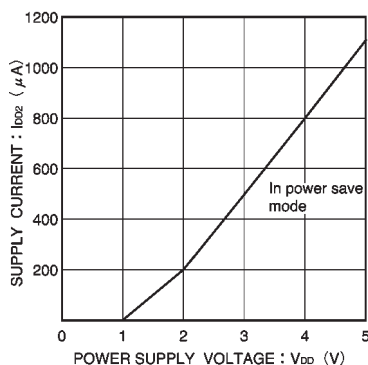


Fig. 10 Supply current vs. power supply voltage (power save mode)

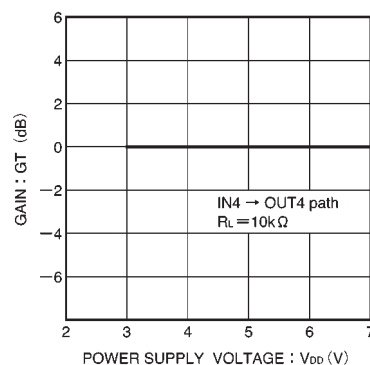


Fig. 11 Gain vs. power supply voltage

●Electrical characteristic curves

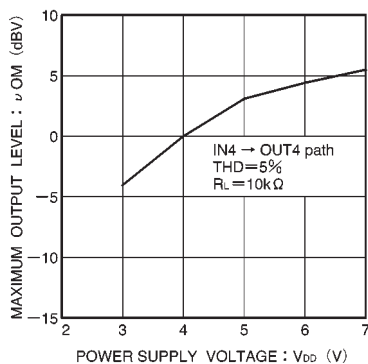


Fig. 12 Maximum output level vs. power supply voltage

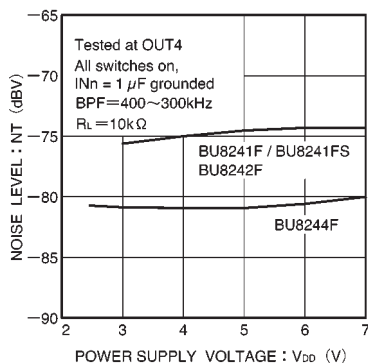


Fig. 13 Noise level vs. power supply voltage

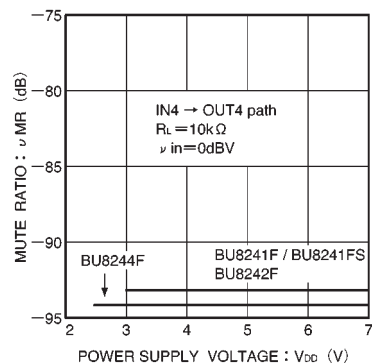


Fig. 14 Mute ratio vs. power supply voltage

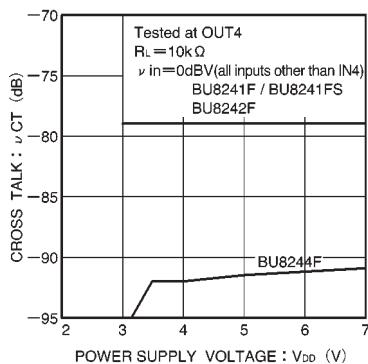


Fig. 15 Crosstalk vs. power supply voltage

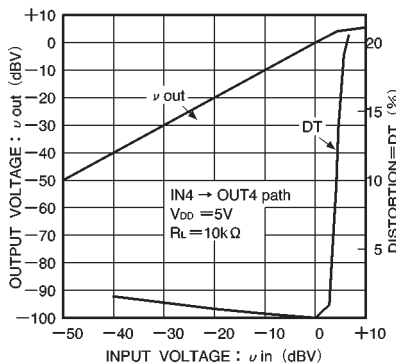


Fig. 16 Input/output characteristic

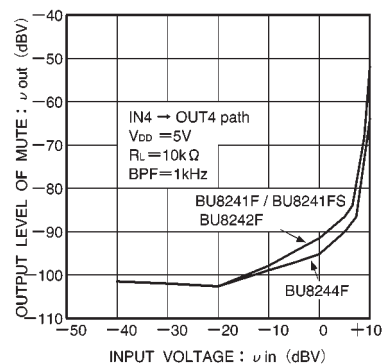


Fig. 17 Output level when muted vs. input voltage

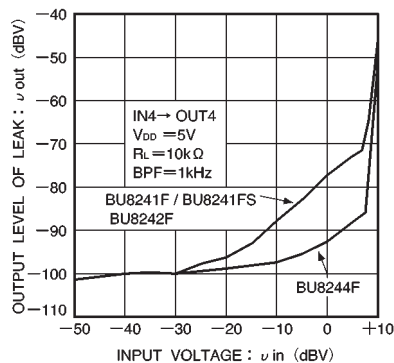
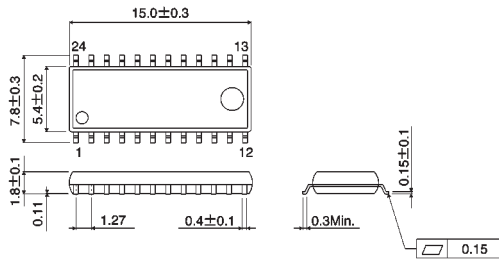


Fig. 18 Output leakage level vs. input voltage

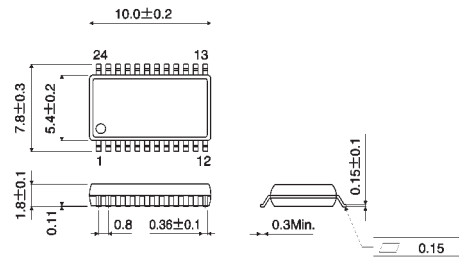
● External dimensions (Units: mm)

BU8241F



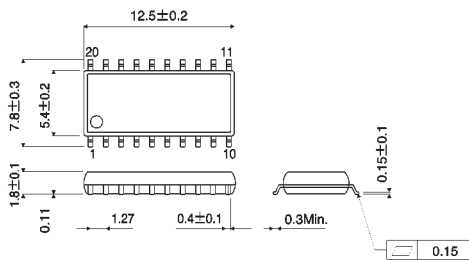
SOP24

BU8241FS



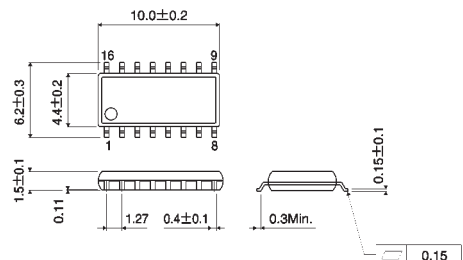
SSOP-A24

BU8242F



SOP20

BU8244F



SOP16

Notes

- No technical content pages of this document may be reproduced in any form or transmitted by any means without prior permission of ROHM CO.,LTD.
- The contents described herein are subject to change without notice. The specifications for the product described in this document are for reference only. Upon actual use, therefore, please request that specifications to be separately delivered.
- Application circuit diagrams and circuit constants contained herein are shown as examples of standard use and operation. Please pay careful attention to the peripheral conditions when designing circuits and deciding upon circuit constants in the set.
- Any data, including, but not limited to application circuit diagrams information, described herein are intended only as illustrations of such devices and not as the specifications for such devices. ROHM CO.,LTD. disclaims any warranty that any use of such devices shall be free from infringement of any third party's intellectual property rights or other proprietary rights, and further, assumes no liability of whatsoever nature in the event of any such infringement, or arising from or connected with or related to the use of such devices.
- Upon the sale of any such devices, other than for buyer's right to use such devices itself, resell or otherwise dispose of the same, no express or implied right or license to practice or commercially exploit any intellectual property rights or other proprietary rights owned or controlled by
- ROHM CO., LTD. is granted to any such buyer.
- Products listed in this document use silicon as a basic material.
Products listed in this document are no antiradiation design.

The products listed in this document are designed to be used with ordinary electronic equipment or devices (such as audio visual equipment, office-automation equipment, communications devices, electrical appliances and electronic toys).

Should you intend to use these products with equipment or devices which require an extremely high level of reliability and the malfunction of which would directly endanger human life (such as medical instruments, transportation equipment, aerospace machinery, nuclear-reactor controllers, fuel controllers and other safety devices), please be sure to consult with our sales representative in advance.

About Export Control Order in Japan

Products described herein are the objects of controlled goods in Annex 1 (Item 16) of Export Trade Control Order in Japan.

In case of export from Japan, please confirm if it applies to "objective" criteria or an "informed" (by MITI clause) on the basis of "catch all controls for Non-Proliferation of Weapons of Mass Destruction.